

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

Rev. 9 — 5 May 2014

**Product data sheet** 

# 1. General description

The PCA9545A/45B/45C is a quad bidirectional translating switch controlled via the I<sup>2</sup>C-bus. The SCL/SDA upstream pair fans out to four downstream pairs, or channels. Any individual SCx/SDx channel or combination of channels can be selected, determined by the contents of the programmable control register. Four interrupt inputs, INTO to INT3, one for each of the downstream pairs, are provided. One interrupt output, INT, acts as an AND of the four interrupt inputs.

An active LOW reset input allows the PCA9545A/45B/45C to recover from a situation where one of the downstream I<sup>2</sup>C-buses is stuck in a LOW state. Pulling the RESET pin LOW resets the I<sup>2</sup>C-bus state machine and causes all the channels to be deselected as does the internal power-on reset function.

The pass gates of the switches are constructed such that the V<sub>DD</sub> pin can be used to limit the maximum high voltage which is passed by the PCA9545A/45B/45C. This allows the use of different bus voltages on each pair, so that 1.8 V or 2.5 V or 3.3 V parts can communicate with 5 V parts without any additional protection. External pull-up resistors pull the bus up to the desired voltage level for each channel. All I/O pins are 5 V tolerant.

The PCA9545A, PCA9545B and PCA9545C are identical except for the fixed portion of the slave address.

# 2. Features and benefits

- 1-of-4 bidirectional translating switches
- I<sup>2</sup>C-bus interface logic; compatible with SMBus standards
- 4 active LOW interrupt inputs
- Active LOW interrupt output
- Active LOW reset input
- 2 address pins allowing up to 4 devices on the I<sup>2</sup>C-bus
- Alternate address versions A, B and C allow up to a total of 12 devices on the bus for larger systems or to resolve address conflicts
- Channel selection via I<sup>2</sup>C-bus, in any combination
- Power-up with all switch channels deselected
- Low R<sub>on</sub> switches
- Allows voltage level translation between 1.8 V, 2.5 V, 3.3 V and 5 V buses
- No glitch on power-up
- Supports hot insertion
- Low standby current
- Operating power supply voltage range of 2.3 V to 5.5 V



- 5 V tolerant Inputs
- 0 Hz to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114 and 1000 V CDM per JESD22-C101
- Latch-up protection exceeds 100 mA per JESD78
- Three packages offered: SO20, TSSOP20, and HVQFN20

# 3. Ordering information

#### Table 1.Ordering information

Type number	Topside	Package	Package						
	marking	Name	Version						
PCA9545ABS	9545A	HVQFN20	plastic thermal enhanced very thin quad flat package; no leads; 20 terminals; body $5 \times 5 \times 0.85$ mm	SOT662-1					
PCA9545AD	PCA9545AD	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1					
PCA9545APW	PA9545A	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1					
PCA9545BPW	PA9545B		body width 4.4 mm						
PCA9545CPW	PA9545C								

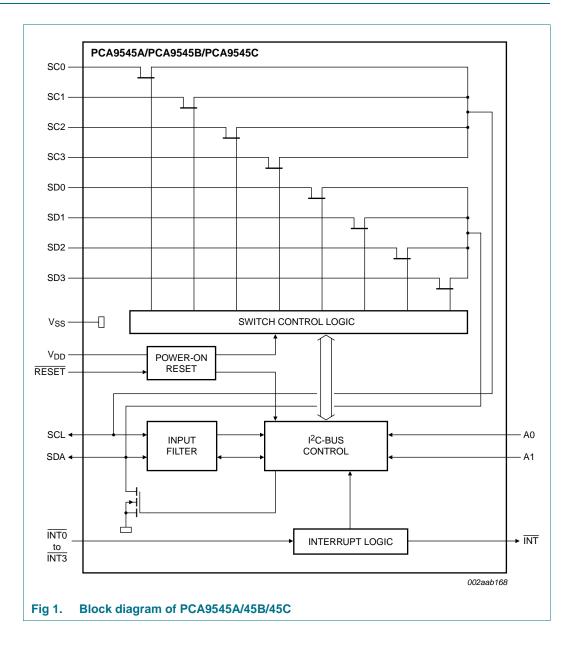
# 3.1 Ordering options

### Table 2.Ordering options

Type number	Orderable part number	Package	Packing method	Minimum order quantity	Temperature range
PCA9545ABS	PCA9545ABS,118	HVQFN20	Reel 13" Q1/T1 *standard mark SMD	6000	$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$
PCA9545AD	CA9545AD PCA9545AD,112 SO20 Standard marking * IC's tube - DSC bulk pack		1520	$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$	
	PCA9545AD,118	SO20	Reel 13" Q1/T1 *standard mark SMD	2000	$T_{amb} = -40 \text{ °C to } +85 \text{ °C}$
PCA9545APW	PCA9545APW,112	TSSOP20	Standard marking * IC's tube - DSC bulk pack	1875	$T_{amb} = -40 \text{ °C to } +85 \text{ °C}$
	PCA9545APW,118	TSSOP20	Reel 13" Q1/T1 *standard mark SMD	2500	$T_{amb} = -40 \text{ °C to } +85 \text{ °C}$
PCA9545BPW	PCA9545BPW,118	TSSOP20	Reel 13" Q1/T1 *standard mark SMD	2500	$T_{amb} = -40 \text{ °C to } +85 \text{ °C}$
PCA9545CPW	PCA9545CPW,118	TSSOP20	Reel 13" Q1/T1 *standard mark SMD	2500	$T_{amb} = -40 \ ^{\circ}C \ to +85 \ ^{\circ}C$

## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

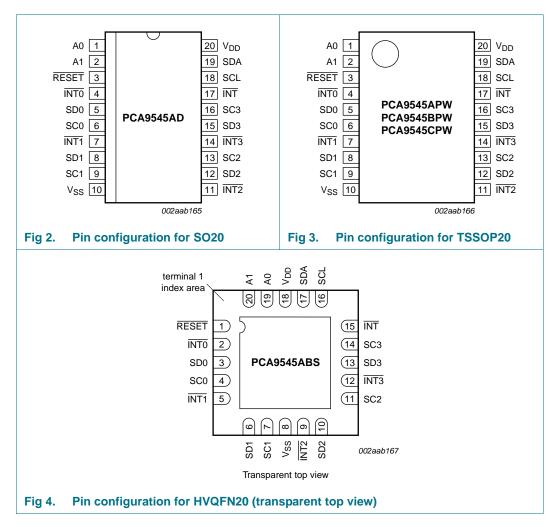
# 4. Block diagram



4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 5. Pinning information

# 5.1 Pinning



## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 5.2 Pin description

### Table 3. Pin description

Symbol	Pin		Description
	SO20, TSSOP20	HVQFN20	_
A0	1	19	address input 0
A1	2	20	address input 1
RESET	3	1	active LOW reset input
INT0	4	2	active LOW interrupt input 0
SD0	5	3	serial data 0
SC0	6	4	serial clock 0
INT1	7	5	active LOW interrupt input 1
SD1	8	6	serial data 1
SC1	9	7	serial clock 1
V <sub>SS</sub>	10	8 <mark>[1]</mark>	supply ground
INT2	11	9	active LOW interrupt input 2
SD2	12	10	serial data 2
SC2	13	11	serial clock 2
INT3	14	12	active LOW interrupt input 3
SD3	15	13	serial data 3
SC3	16	14	serial clock 3
INT	17	15	active LOW interrupt output
SCL	18	16	serial clock line
SDA	19	17	serial data line
V <sub>DD</sub>	20	18	supply voltage

[1] HVQFN20 package die supply ground is connected to both the V<sub>SS</sub> pin and the exposed center pad. The V<sub>SS</sub> pin must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board-level performance, the exposed pad must be soldered to the board using a corresponding thermal pad on the board, and for proper heat conduction through the board thermal vias must be incorporated in the PCB in the thermal pad region.

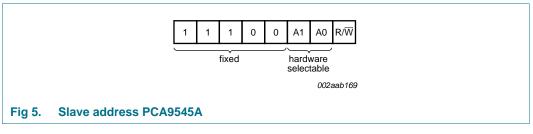
### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 6. Functional description

Refer to Figure 1 "Block diagram of PCA9545A/45B/45C".

### 6.1 Device address

Following a START condition, the bus master must output the address of the slave it is accessing. The address of the PCA9545A is shown in <u>Figure 5</u>. To conserve power, no internal pull-up resistors are incorporated on the hardware selectable address pins and they must be pulled HIGH or LOW.



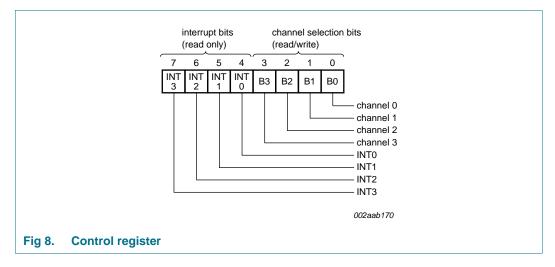
The last bit of the slave address defines the operation to be performed. When set to logic 1, a read is selected while a logic 0 selects a write operation.

The PCA9545BPW and PCA9545CPW are alternate address versions if needed for larger systems or to resolve conflicts. The data sheet references the PCA9545A, but the PCA9545B and PCA9545C function identically except for the slave address.

1 1 0 1 0 A1 A0 R/W	1 0 1 1 0 A1 A0 R/W
fixed hardware selectable	fixed hardware selectable
002aab835	002aab836
Fig 6. Slave address PCA9545B	Fig 7. Slave address PCA9545C

## 6.2 Control register

Following the successful acknowledgement of the slave address, the bus master sends a byte to the PCA9545A/45B/45C, which is stored in the control register. If multiple bytes are received by the PCA9545A/45B/45C, it saves the last byte received. This register can be written and read via the I<sup>2</sup>C-bus.



### 6.2.1 Control register definition

One or several SCx/SDx downstream pair, or channel, is selected by the contents of the control register. This register is written after the PCA9545A/45B/45C has been addressed. The 4 LSBs of the control byte are used to determine which channel is to be selected. When a channel is selected, the channel will become active after a STOP condition has been placed on the I<sup>2</sup>C-bus. This ensures that all SCx/SDx lines are in a HIGH state when the channel is made active, so that no false conditions are generated at the time of connection.

INT3	INT2	INT1	INT0	B3	B2	B1	B0	Command
х	х	х	х	х	х	х	0	channel 0 disabled
^	^	^	^	^	^	^	1	channel 0 enabled
x	x	х	x	х	x	0	X	channel 1 disabled
^	^	^	^	^	^	1	^	channel 1 enabled
x	x	x	х	х	0	v	х	channel 2 disabled
^	^	^	^	^	1	X	^	channel 2 enabled
x	x	x	х	0	X	х	х	channel 3 disabled
^	^	^	^	1	^	^	^	channel 3 enabled
0	0	0	0	0	0	0	0	no channel selected; power-up/reset default state

 Table 4.
 Control register: write (channel selection); read (channel status)

**Remark:** Several channels can be enabled at the same time. Example: B3 = 0, B2 = 1, B1 = 1, B0 = 0, means that channel 0 and channel 3 are disabled and channel 1 and channel 2 are enabled. Care should be taken not to exceed the maximum bus capacity.

PCA9545A\_45B\_45C
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### 6.2.2 Interrupt handling

The PCA9545A/45B/45C provides 4 interrupt inputs, one for each channel, and one open-drain interrupt output. When an interrupt is generated by any device, it is detected by the PCA9545A/45B/45C and the interrupt output is driven LOW. The channel does not need to be active for detection of the interrupt. A bit is also set in the control register.

Bit 4 through bit 7 of the control register corresponds to channel 0 through channel 3 of the PCA9545A/45B/45C, respectively. Therefore, if an interrupt is generated by any device connected to channel 1, the state of the interrupt inputs is loaded into the control register when a read is accomplished. Likewise, an interrupt on any device connected to channel 0 would cause bit 4 of the control register to be set on the read. The master can then address the PCA9545A/45B/45C and read the contents of the control register to determine which channel contains the device generating the interrupt. The master can then reconfigure the PCA9545A/45B/45C to select this channel, and locate the device generating the interrupt and clear it.

It should be noted that more than one device can provide an interrupt on a channel, so it is up to the master to ensure that all devices on a channel are interrogated for an interrupt.

If the interrupt function is not required, the interrupt inputs may be used as general-purpose inputs.

If unused, interrupt inputs must be connected to  $V_{\text{DD}}$  through a pull-up resistor.

INT3	INT2	INT1	INT0	B3	B2	B1	B0	Command					
х	х	х	0	x	х	х	х	no interrupt on channel 0					
^	^	^	1	^	^	^	^	interrupt on channel 0					
х	х	0	x	х	х	х	х	no interrupt on channel 1					
^		1	^	^	^	^	^	^	interrupt on channel 1				
v	0	v	х	х	v	×	V	no interrupt on channel 2					
Х	1	_X	^		~	X	~	^	^	Х	^	Х	Х
0	v	v	v	v	v	v	v	no interrupt on channel 3					
1	X	Х	Х	Х	Х	Х	Х	interrupt on channel 3					

 Table 5.
 Control register: Read — interrupt

**Remark:** Several interrupts can be active at the same time. Example: INT3 = 0, INT2 = 1, INT1 = 1, INT0 = 0, means that there is no interrupt on channel 0 and channel 3, and there is interrupt on channel 1 and channel 2.

# 6.3 **RESET** input

The RESET input is an active LOW signal which may be used to recover from a bus fault condition. By asserting this signal LOW for a minimum of  $t_{w(rst)L}$ , the PCA9545A/45B/45C resets its registers and I<sup>2</sup>C-bus state machine and deselects all channels. The RESET input must be connected to V<sub>DD</sub> through a pull-up resistor.

### 6.4 Power-on reset

When power is applied to V<sub>DD</sub>, an internal Power-On Reset (POR) holds the PCA9545A/45B/45C in a reset condition until V<sub>DD</sub> has reached V<sub>POR</sub>. At this point, the reset condition is released and the PCA9545A/45B/45C registers and I<sup>2</sup>C-bus state machine are initialized to their default states (all zeroes) causing all the channels to be deselected. Thereafter, V<sub>DD</sub> must be lowered below 0.2 V for at least 5  $\mu$ s in order to reset the device.

### 6.5 Voltage translation

The pass gate transistors of the PCA9545A/45B/45C are constructed such that the  $V_{DD}$  voltage can be used to limit the maximum voltage that is passed from one I<sup>2</sup>C-bus to another.

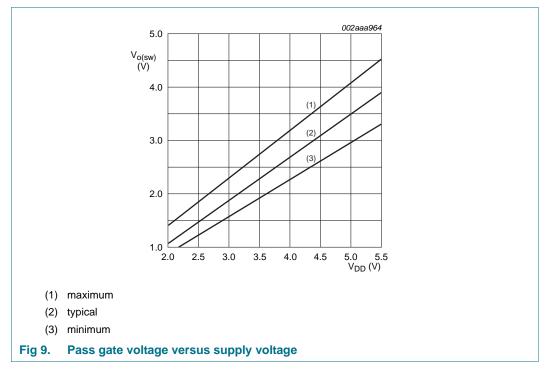


Figure 9 shows the voltage characteristics of the pass gate transistors (note that the graph was generated using the data specified in Section 11 "Static characteristics" of this data sheet). In order for the PCA9545A/45B/45C to act as a voltage translator, the  $V_{o(sw)}$  voltage should be equal to, or lower than the lowest bus voltage. For example, if the main bus was running at 5 V, and the downstream buses were 3.3 V and 2.7 V, then  $V_{o(sw)}$  should be equal to or below 2.7 V to clamp the downstream bus voltages effectively. Looking at Figure 9, we see that  $V_{o(sw)(max)}$  is at 2.7 V when the PCA9545A/45B/45C supply voltage is 3.5 V or lower, so the PCA9545A/45B/45C supply voltage could be set to 3.3 V. Pull-up resistors can then be used to bring the bus voltages to their appropriate levels (see Figure 16).

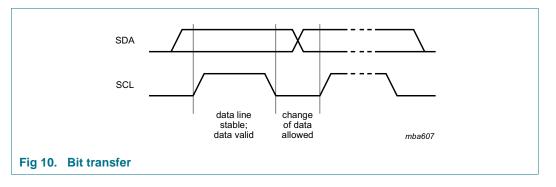
More Information can be found in Application Note AN262: PCA954X family of I<sup>2</sup>C/SMBus multiplexers and switches.

# 7. Characteristics of the l<sup>2</sup>C-bus

The I<sup>2</sup>C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

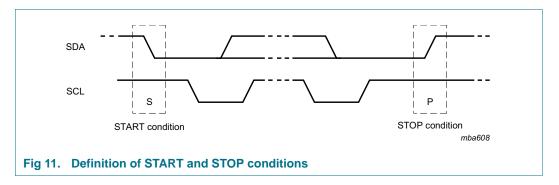
## 7.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse, as changes in the data line at this time are interpreted as control signals (see Figure 10).



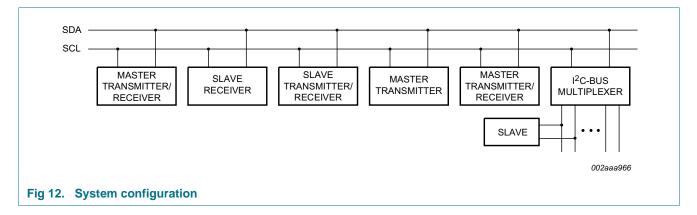
# 7.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P) (see Figure 11).



## 7.3 System configuration

A device generating a message is a 'transmitter', a device receiving is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves' (see Figure 12).

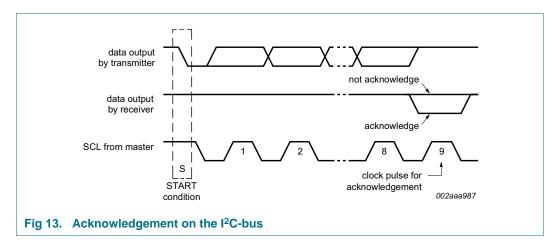


# 7.4 Acknowledge

The number of data bytes transferred between the START and the STOP conditions from transmitter to receiver is not limited. Each byte of 8 bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter, whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse; set-up and hold times must be taken into account.

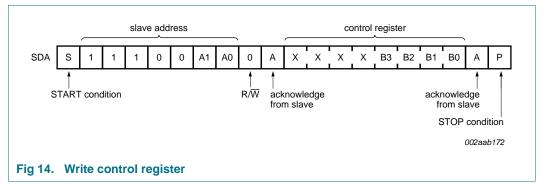
A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.



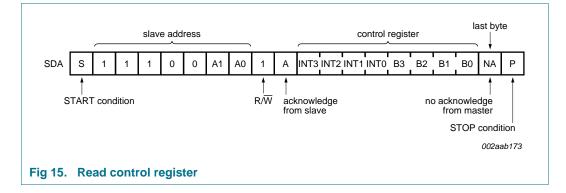
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## 7.5 Bus transactions

Data is transmitted to the PCA9545A/45B/45C control register using the Write mode as shown in Figure 14.

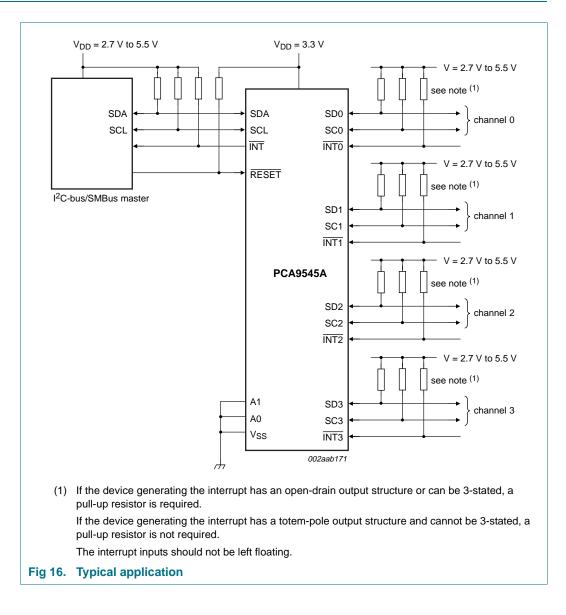


Data is read from PCA9545A/45B/45C using the Read mode as shown in Figure 15.



## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 8. Application design-in information



## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 9. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS}$  (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DD</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I <sub>I</sub>	input current		-	±20	mA
lo	output current		-	±25	mA
I <sub>DD</sub>	supply current		-	±100	mA
I <sub>SS</sub>	ground supply current		-	±100	mA
P <sub>tot</sub>	total power dissipation		-	400	mW
T <sub>j(max)</sub>	maximum junction temperature	[1]	-	125	°C
T <sub>stg</sub>	storage temperature		-60	+150	°C
T <sub>amb</sub>	ambient temperature	operating	-40	+85	°C

[1] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 125 °C.

# **10. Thermal characteristics**

Table 7.         Thermal characteristics									
Symbol	Parameter	Conditions	Тур	Unit					
R <sub>th(j-a)</sub>	thermal resistance from junction	HVQFN20 package	32	°C/W					
	to ambient	SO20 package	90	°C/W					
		TSSOP20 package	146	°C/W					

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# **11. Static characteristics**

## Table 8. Static characteristics at V<sub>DD</sub> = 2.3 V to 3.6 V

 $V_{SS} = 0$  V;  $T_{amb} = -40$  °C to +85 °C; unless otherwise specified. See <u>Table 9 on page 16</u> for  $V_{DD} = 4.5$  V to 5.5 V[1].

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply						
V <sub>DD</sub>	supply voltage		2.3	-	3.6	V
I <sub>DD</sub>	supply current	Operating mode; $V_{DD}$ = 3.6 V; no load; V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub> ; f <sub>SCL</sub> = 100 kHz	-	10	30	μA
I <sub>stb</sub>	standby current	Standby mode; $V_{DD}$ = 3.6 V; no load; $V_I = V_{DD}$ or $V_{SS}$	-	0.1	1	μA
V <sub>POR</sub>	power-on reset voltage	no load; $V_I = V_{DD}$ or $V_{SS}$ [2]	-	1.6	2.1	V
Input SC	L; input/output SDA		<u> </u>			
V <sub>IL</sub>	LOW-level input voltage		-0.5	-	+0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		$0.7V_{DD}$	-	6	V
I <sub>OL</sub>	LOW-level output current	V <sub>OL</sub> = 0.4 V	3	7	-	mA
		V <sub>OL</sub> = 0.6 V	6	10	-	mA
IL	leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	-	+1	μA
Ci	input capacitance	$V_{I} = V_{SS}$	-	10	13	pF
Select in	puts A0, A1, INTO to INT3, F	RESET	<u> </u>			
V <sub>IL</sub>	LOW-level input voltage		-0.5	-	+0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		$0.7V_{DD}$	-	6	V
ILI	input leakage current	pin at $V_{DD}$ or $V_{SS}$	-1	-	+1	μA
Ci	input capacitance	$V_{I} = V_{SS}$	-	1.6	3	pF
Pass gat	9		<u> </u>			
Ron	ON-state resistance	$V_{DD}$ = 3.6 V; $V_{O}$ = 0.4 V; $I_{O}$ = 15 mA	5	11	30	Ω
		$V_{DD}$ = 2.3 V to 2.7 V; $V_{O}$ = 0.4 V; $I_{O}$ = 10 mA	7	16	55	Ω
V <sub>o(sw)</sub>	switch output voltage	$V_{i(sw)} = V_{DD} = 3.3 \text{ V}; I_{o(sw)} = -100 \mu\text{A}$	-	1.9	-	V
		$V_{i(sw)} = V_{DD} = 3.0 \text{ V to } 3.6 \text{ V};$ $I_{o(sw)} = -100 \mu\text{A}$	1.6	-	2.8	V
		$V_{i(sw)} = V_{DD} = 2.5 \text{ V}; I_{o(sw)} = -100 \mu\text{A}$	-	1.5	-	V
		$V_{i(sw)} = V_{DD} = 2.3 \text{ V to } 2.7 \text{ V};$ $I_{o(sw)} = -100 \mu\text{A}$	1.1	-	2.0	V
۱L	leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	-	+1	μA
Cio	input/output capacitance	$V_{I} = V_{SS}$	-	3	5	pF
INT outp	ut	,	1		I	
I <sub>OL</sub>	LOW-level output current	V <sub>OL</sub> = 0.4 V	3	-	-	mA
I <sub>OH</sub>	HIGH-level output current		-	-	+10	μA

[1] For operation between published voltage ranges, refer to the worst-case parameter in both ranges.

[2]  $V_{DD}$  must be lowered to 0.2 V for at least 5  $\mu$ s in order to reset part.

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply						
V <sub>DD</sub>	supply voltage		4.5	-	5.5	V
I <sub>DD</sub>	supply current	Operating mode; $V_{DD} = 5.5 V$ ; no load; $V_I = V_{DD}$ or $V_{SS}$ ; $f_{SCL} = 100 \text{ kHz}$	-	25	100	μA
I <sub>stb</sub>	standby current	Standby mode; $V_{DD} = 5.5 V$ ; no load; $V_I = V_{DD}$ or $V_{SS}$	-	0.3	1	μA
V <sub>POR</sub>	power-on reset voltage	no load; $V_I = V_{DD}$ or $V_{SS}$	<u>l</u> -	1.7	2.1	V
Input SCL	; input/output SDA					
V <sub>IL</sub>	LOW-level input voltage		-0.5	-	+0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		$0.7V_{DD}$	-	6	V
I <sub>OL</sub>	LOW-level output current	V <sub>OL</sub> = 0.4 V	3	-	-	mA
		V <sub>OL</sub> = 0.6 V	6	-	-	mA
IL	leakage current	$V_{I} = V_{SS}$	-1	-	+1	μA
Ci	input capacitance	V <sub>I</sub> = V <sub>SS</sub>	-	10	13	pF
Select inp	outs A0, A1, INTO to INT3, R	ESET				
V <sub>IL</sub>	LOW-level input voltage		-0.5	-	+0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		$0.7V_{DD}$	-	6	V
ILI	input leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	-	+1	μA
Ci	input capacitance	$V_{I} = V_{SS}$	-	2	5	pF
Pass gate	)					
R <sub>on</sub>	ON-state resistance	$V_{DD}$ = 4.5 V to 5.5 V; $V_{O}$ = 0.4 V; $I_{O}$ = 15 mA	4	9	24	Ω
V <sub>o(sw)</sub>	switch output voltage	$V_{i(sw)} = V_{DD} = 5.0 V;$ $I_{o(sw)} = -100 \ \mu A$	-	3.6	-	V
		$\label{eq:Vi(sw)} \begin{split} V_{i(sw)} &= V_{DD} = 4.5 \ V \ to \ 5.5 \ V; \\ I_{o(sw)} &= -100 \ \mu A \end{split}$	2.6	-	4.5	V
IL	leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	-	+1	μA
C <sub>io</sub>	input/output capacitance	$V_{I} = V_{SS}$	-	3	5	pF
INT outpu	t					
I <sub>OL</sub>	LOW-level output current	V <sub>OL</sub> = 0.4 V	3	-	-	mA
I <sub>OH</sub>	HIGH-level output current		-	-	+10	μA

**Table 9.** Static characteristics at  $V_{DD} = 4.5 \text{ V}$  to 5.5 V $V_{CC} = 0 \text{ V}$ :  $T_{cont} = -40 \text{ C}$  to +85 C: unless otherwise specified. See Table 8 on page 15 for  $V_{DD}$ 23V to 36V[1]

[1] For operation between published voltage ranges, refer to the worst-case parameter in both ranges.

[2]  $V_{DD}$  must be lowered to 0.2 V for at least 5  $\mu$ s in order to reset part.

## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# **12. Dynamic characteristics**

#### Table 10. Dynamic characteristics

Symbol	Parameter	Conditions			rd-mode -bus	Fast-mode I <sup>2</sup> C-bus		Unit	
				Min Max		Min Max		1	
t <sub>PD</sub>	propagation delay	from SDA to SDx, or SCL to SCx		-	0.3[1]	-	0.3 <mark>[1]</mark>	ns	
f <sub>SCL</sub>	SCL clock frequency			0	100	0	400	kHz	
t <sub>BUF</sub>	bus free time between a STOP and START condition			4.7	-	1.3	-	μs	
t <sub>HD;STA</sub>	hold time (repeated) START condition		[2]	4.0	-	0.6	-	μS	
t <sub>LOW</sub>	LOW period of the SCL clock			4.7	-	1.3	-	μS	
t <sub>HIGH</sub>	HIGH period of the SCL clock			4.0	-	0.6	-	μS	
t <sub>SU;STA</sub>	set-up time for a repeated START condition			4.7	-	0.6	-	μS	
t <sub>SU;STO</sub>	set-up time for STOP condition			4.0	-	0.6	-	μS	
t <sub>HD;DAT</sub>	data hold time			0[3]	3.45	0 <u>[3]</u>	0.9	μS	
t <sub>SU;DAT</sub>	data set-up time			250	-	100	-	ns	
t <sub>r</sub>	rise time of both SDA and SCL signals			-	1000	20 + 0.1C <sub>b</sub> <sup>[4]</sup>	300	ns	
t <sub>f</sub>	fall time of both SDA and SCL signals			-	300	20 + 0.1C <sub>b</sub> <sup>[4]</sup>	300	ns	
C <sub>b</sub>	capacitive load for each bus line			-	400	-	400	pF	
t <sub>SP</sub>	pulse width of spikes that must be suppressed by the input filter			-	50	-	50	ns	
t <sub>VD;DAT</sub>	data valid time	HIGH-to-LOW	[5]	-	1	-	1	μs	
		LOW-to-HIGH	[5]	-	0.6	-	0.6	μS	
t <sub>VD;ACK</sub>	data valid acknowledge time			-	1	-	1	μS	
INT									
t <sub>v(INTnN-INTN)</sub>	valid time from INTn to INT signal			-	4	-	4	μS	
t <sub>d(INTnN-INTN)</sub>	delay time from INTn to INT inactive			-	2	-	2	μS	
t <sub>w(rej)L</sub>	LOW-level rejection time	INTn inputs		1	-	1	-	μS	
t <sub>w(rej)H</sub>	HIGH-level rejection time	INTn inputs		0.5	-	0.5	-	μS	
RESET									
t <sub>w(rst)L</sub>	LOW-level reset time			4	-	4	-	ns	
t <sub>rst</sub>	reset time	SDA clear		500	-	500	-	ns	
t <sub>REC;STA</sub>	recovery time to START condition			0	-	0	-	ns	

[1] Pass gate propagation delay is calculated from the 20  $\Omega$  typical R<sub>on</sub> and the 15 pF load capacitance.

[2] After this period, the first clock pulse is generated.

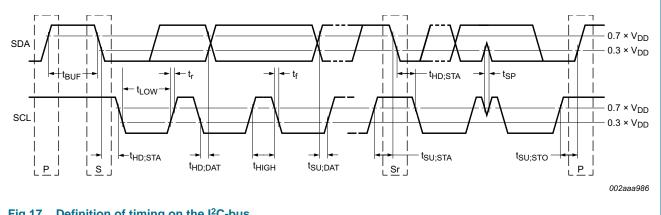
[3] A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V<sub>IH(min)</sub> of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

[4]  $C_b$  = total capacitance of one bus line in pF.

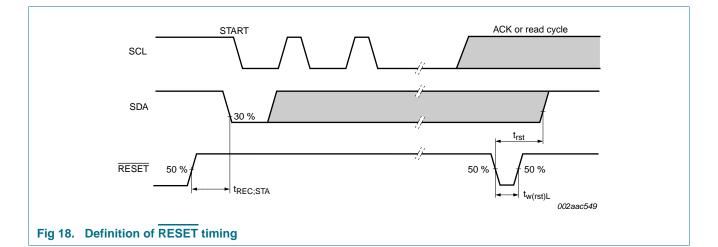
[5] Measurements taken with 1 k $\Omega$  pull-up resistor and 50 pF load.

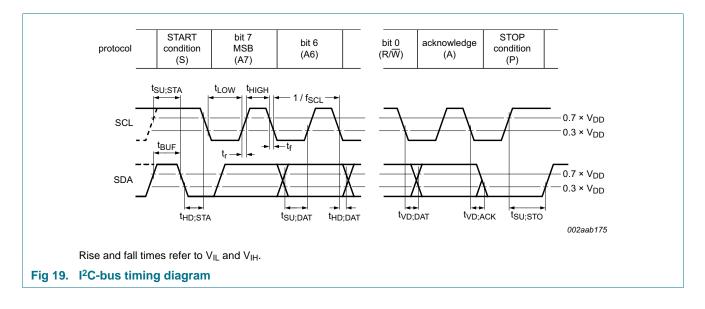
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## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

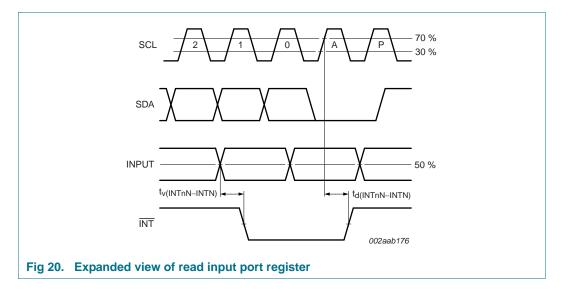


# Fig 17. Definition of timing on the I<sup>2</sup>C-bus

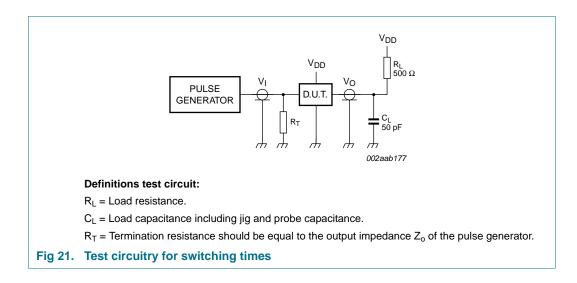




## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



# **13. Test information**

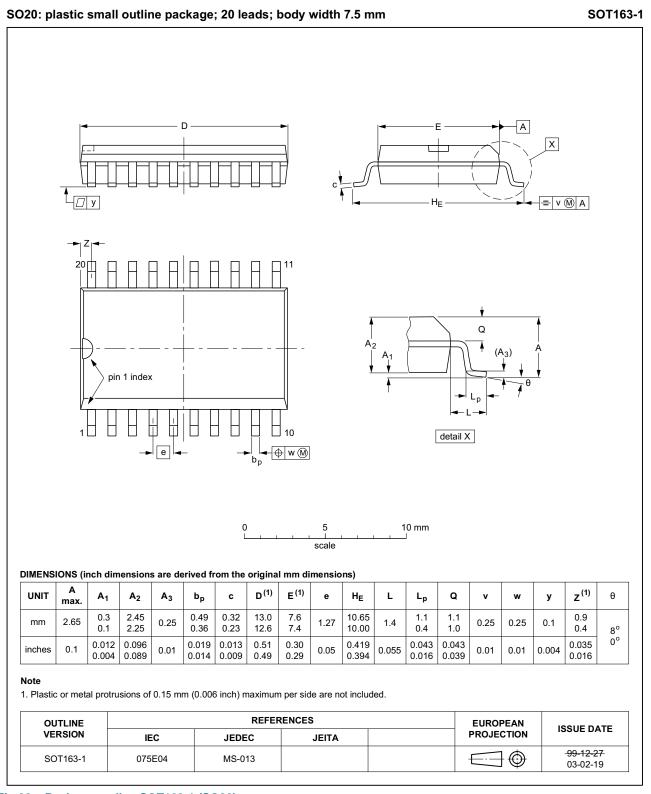


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4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

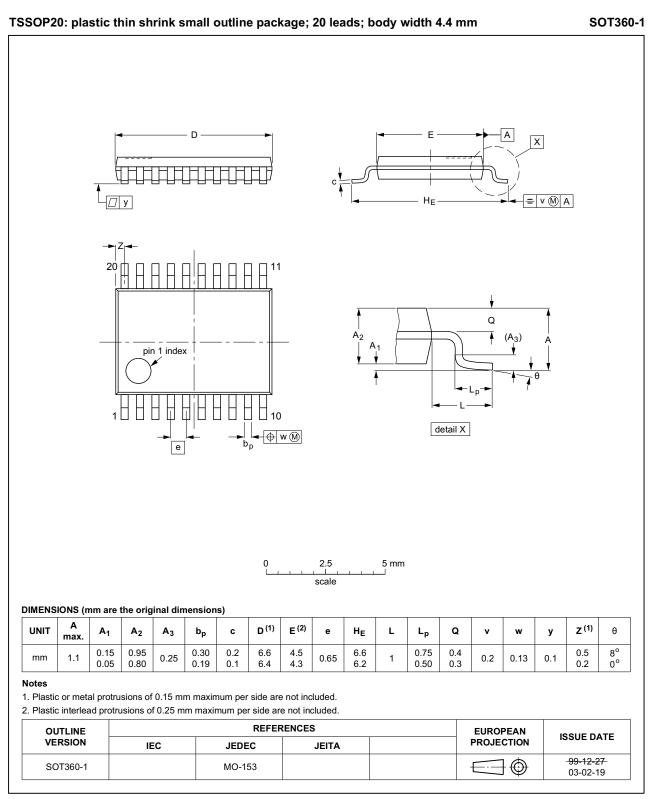
# 14. Package outline



#### Fig 22. Package outline SOT163-1 (SO20)

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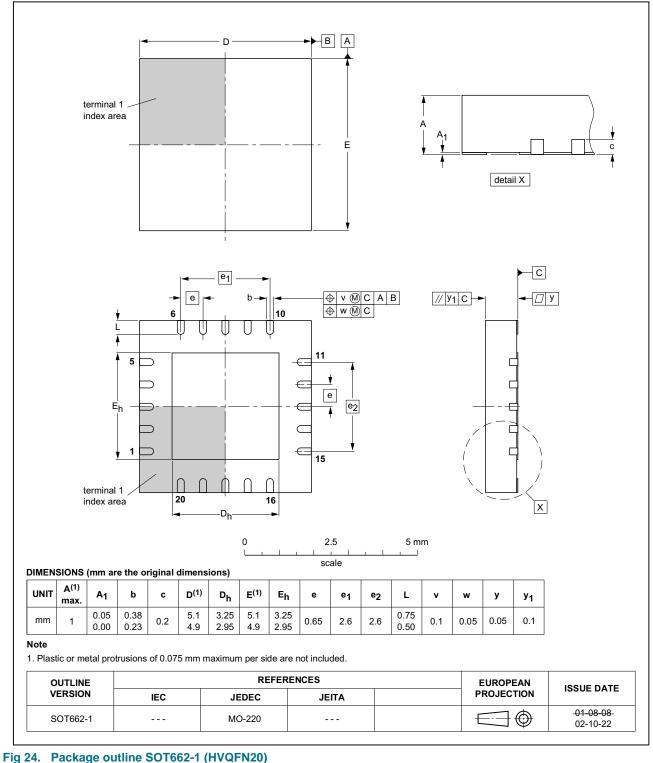
4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



### Fig 23. Package outline SOT360-1 (TSSOP20)

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4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



#### HVQFN20: plastic thermal enhanced very thin quad flat package; no leads; 20 terminals; body 5 x 5 x 0.85 mm

SOT662-1

# 15. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note AN10365 "Surface mount reflow soldering description".

## 15.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

## 15.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

### 15.3 Wave soldering

Key characteristics in wave soldering are:

- · Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

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## 15.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 25</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 11 and 12

#### Table 11. SnPb eutectic process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)					
	Volume (mm <sup>3</sup> )					
	< 350	≥ 350				
< 2.5	235	220				
≥ 2.5	220	220				

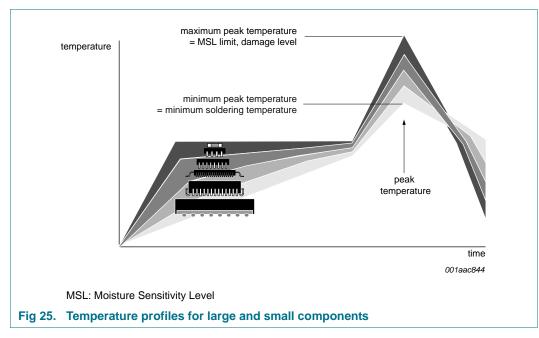
#### Table 12. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C) Volume (mm <sup>3</sup> )			
	< 350	350 to 2000	> 2000	
< 1.6	260	260	260	
1.6 to 2.5	260	250	245	
> 2.5	250	245	245	

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 25.

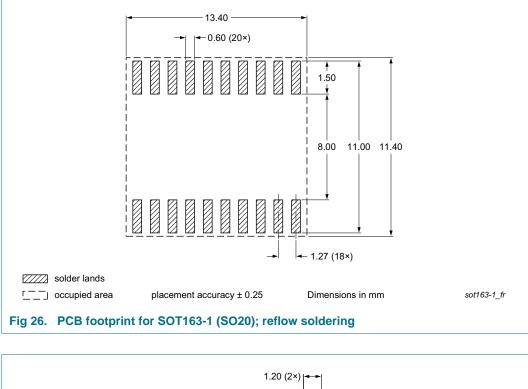
## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

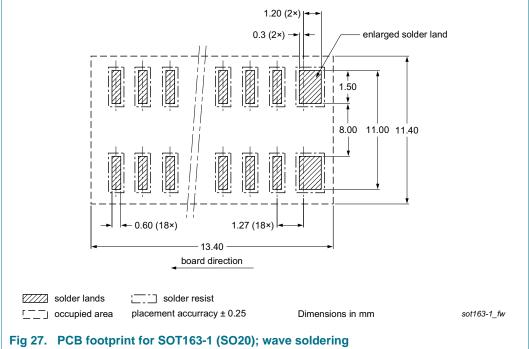


For further information on temperature profiles, refer to Application Note *AN10365 "Surface mount reflow soldering description"*.

## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# **16. Soldering: PCB footprints**





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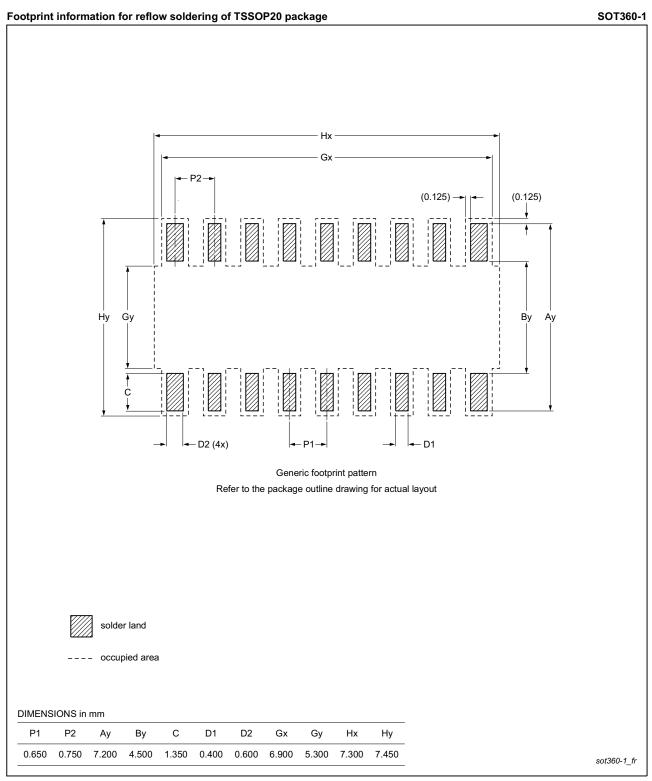


Fig 28. PCB footprint for SOT360-1 (TSSOP20); reflow soldering

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### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

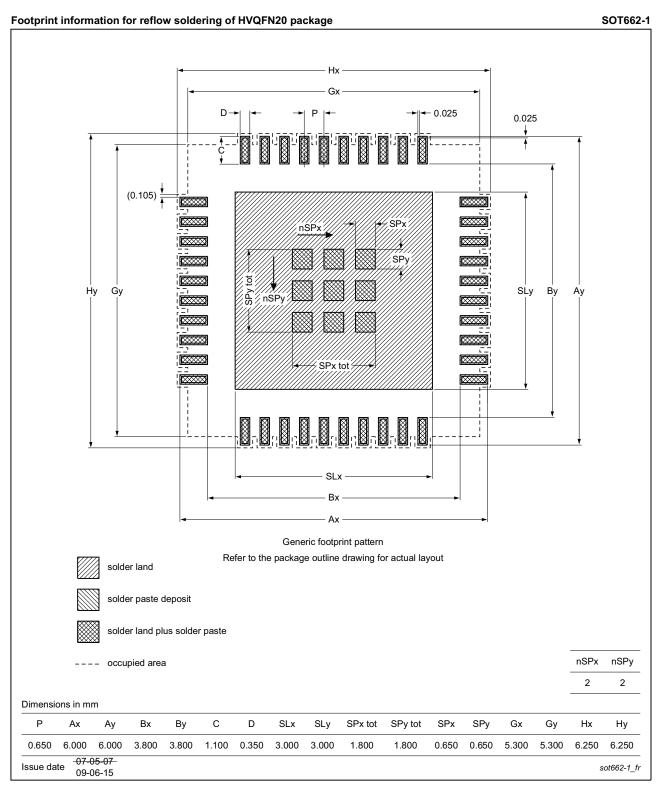


Fig 29. PCB footprint for SOT662-1 (HVQFN20); reflow soldering

## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# **17. Abbreviations**

Table 13. Abbreviations				
Acronym	Description			
CDM	Charged-Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			
IC	Integrated Circuit			
I <sup>2</sup> C-bus	Inter-Integrated Circuit bus			
LSB	Least Significant Bit			
MSB	Most Significant Bit			
PCB	Printed-Circuit Board			
POR	Power-On Reset			
SMBus	System Management Bus			

# **18. Revision history**

### Table 14.Revision history

			1		
Document ID	Release date	Data sheet status	Change notice	Supersedes	
PCA9545A_45B_45C v.9	20140505	Product data sheet	-	PCA9545A_45B_45C v.8	
Modifications:	<ul> <li><u>Section 6.4 "Power-on reset</u>", first paragraph, third sentence corrected from "Thereafter, V<sub>DD</sub> must be lowered below 0.2 V to reset the device." to "Thereafter, V<sub>DD</sub> must be lowered below 0.2 V for at least 5 μs in order to reset the device." (this is a correction to documentation only; no change to device)</li> </ul>				
		$c characteristics at V_{DD} = 2.3 V$ least 5 µs" (this is a correction			
		c characteristics at V <sub>DD</sub> = 4.5 V least 5 $\mu$ s" (this is a correction			
PCA9545A_45B_45C v.8	20130514	Product data sheet	-	PCA9545A_45B_45C v.7	
PCA9545A_45B_45C v.7	20090619	Product data sheet	-	PCA9545A_45B_45C v.6	
PCA9545A_45B_45C v.6	20070319	Product data sheet	-	PCA9545A_45B_45C v.5	
PCA9545A_45B_45C v.5	20061017	Product data sheet	-	PCA9545A v.4	
PCA9545A v.4	20060925	Product data sheet	-	PCA9545A v.3	
PCA9545A v.3	20050303	Product data sheet	-	PCA9545A v.2	
PCA9545A v.2	20040929	Objective data sheet	-	PCA9545A v.1	
PCA9545A v.1	20040728	Objective data sheet	-	-	

# **19. Legal information**

## **19.1 Data sheet status**

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

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4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

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